

APPLICABLE STANDARD					
RATING 	OPERATING TEMPERATURE RANGE	-40°C TO + 85°C (NOTE 1)	STORAGE TEMPERATURE RANGE		-10°C TO + 60°C (NOTE 2)
	OPERATING HUMIDITY RANGE	40% TO 80% (NOTE 3)	STORAGE HUMIDITY RANGE		40% TO 70% (NOTE 2)
	VOLTAGE	250V AC/DC	UL · CSA RATING	VOLTAGE	30V AC
	CURRENT	AWG#22 : 2A AWG#24-28 : 1A AWG#30 : 0.5A		CURRENT	AWG#22 : 2A AWG#24-28 : 1A AWG#30 : 0.5A
	APPLICABLE CONNECTOR	DF11-**DS-2C (##)		APPLICABLE CONTACT DF11-**SC (F) (##)	
SPECIFICATIONS					
ITEM		TEST METHOD		REQUIREMENTS	QT AT
CONSTRUCTION					
GENERAL EXAMINATION		VISUALLY AND BY MEASURING INSTRUMENT.		ACCORDING TO DRAWING.	X X
MARKING		CONFIRMED VISUALLY.			X X
ELECTRIC CHARACTERISTICS					
CONTACT RESISTANCE		100mA (DC OR 1000 Hz).		30mΩ MAX.	X —
INSULATION RESISTANCE		500V DC.		1000MΩ MIN.	X —
VOLTAGE PROOF		650V AC FOR 1 min.		NO FLASHOVER OR BREAKDOWN.	X —
MECHANICAL CHARACTERISTICS					
MECHANICAL OPERATION		30TIMES INSERTIONS AND EXTRACTIONS.		① CONTACT RESISTANCE: 30mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X —
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.		① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X —
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.		① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X —
ENVIRONMENTAL CHARACTERISTICS					
DAMP HEAT (STEADY STATE)		EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.		① CONTACT RESISTANCE: 30mΩ MAX. ② INSULATION RESISTANCE: 500MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X —
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -55→ 5 TO 35→+85→ 5 TO 35°C TIME 30→ 5MAX → 30→ 5MAX min UNDER 5 CYCLES.		① CONTACT RESISTANCE: 30mΩ MAX. ② INSULATION RESISTANCE: 1000MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X —
RESISTANCE TO SOLDERING HEAT		1)AUTOMATIC SOLDERING (FLOW) SOLDER TEMPERATURE : 260°C FOR IMMERSION,DURATION , 10 sec . 2)MANUAL SOLDERING SOLDERING IRON TEMPERATURE : 300°C SOLDERING TIME : 2 sec. NO STRENGTH ON CONTACT.		NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X —
SOLDERABILITY		SOLDERED AT SOLDER TEMPERATURE, 230°C FOR INSERTION DURATION, 3sec.		SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSSED.	X —
	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
	1	DIS-H-00004051	TS. MIYAKI	SZ. ONO	18. 07. 20
REMARKS				APPROVED	KJ. KATAYOSE
NOTE1:INCLUDING THE TEMPERATURE RISE BY CURRENT				CHECKED	TY. OMA
NOTE2: APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE MOUNTED ON PCB. AFTER MOUNTED ON PCB, OPERATION TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERIM STORAGE DURING TRANSPORTATION.				DESIGNED	IO. DENPOUYA
NOTE3:NON-CONDENSING. Unless otherwise specified , refer to IEC 60512.				DRAWN	IO. DENPOUYA
Note QT:Qualification Test AT:Assurance Test X:Applicable Test			DRAWING NO.		ELC4-084377-01
	SPECIFICATION SHEET		PART NO.	DF11-**DP-2DSA (08)	
	HIROSE ELECTRIC CO., LTD.		CODE NO.	CL543	 1/1